	2004/02/24 10:18	USPAT; US-PGPUB	(security near2 (strip thread)) same (hologram holographic) and @pd>20030727	J.	BRS	179
	2004/02/24 10:16	USPAT; US-PGPUB	3 nea and holog	<u> </u>	BRS	178
	2004/02/24	USPAT; US-PGPUB	(security near2 ologram optical\$2 d>20030727	Н Н	BRS	177
	2004/02/24 10:13	USPAT; US-PGPUB	lear5 (s ld @pd>2	Ľ	BRS	176
	2004/02/24 10:12	USPAT; US-PGPUB	y passposame (o: 030727	0	BRS	175
	2004/02/24 10:12	USPAT; US-PGPUB	((paper cardboard currency passport) near5 (ic chip semiconduct\$3)) and (security near2 (strip thread)) and @pd>20030727	0	BRS	174
	2004/02/24 10:12	USPAT; US-PGPUB	((paper cardboard currency passport) near5 (ic chip semiconduct\$3)) same (security near2 (strip thread)) and @pd>20030727	0	BRS	173
	2004/02/24 10:08	USPAT; US-PGPUB	((paper cardboard) near5 (IC (integrated adj circuit) chip)) same (organic polymer) and @pd>20030727	10	BRS	172
	2004/02/24 09:56	USPAT; US-PGPUB	((paper cardboard) near5 (IC (integrated adj circuit) chip)) same (thread strip security forgery authentic\$3) and @pd>20030727	4	BRS	171
	2004/02/24 09:51	DERWENT	(Krul-J.in. Hart-C.in. DeLeeuw-D.in. DeHesse-W.in. Matters-M.in.) and @pd>20030727	4	BRS	170
	2004/02/24 09:50	USPAT; US-PGPUB; EPO; JPO	(Krul-Johannes.in. Hart-Cornelius-Maria.in. DeLeeuw-Dagobert-Michel.in. DeHesse-Wilhelm-Bernardus.in. Matters-Marco.in.) and @pd>20030727	H	BRS	169
Error	Time Stamp e	DBs	Search Text	Hits	Туре	

		2004/02/24 11:20	EPO; JPO; DERWENT; IBM_TDB	(security adj1 (document\$1 paper\$1 thread\$1 strip\$1))) same (IC chip circuit semiconductor semiconducting) and @pd>20030727	46	BRS	188
		2004/02/24	USPAT; US-PGPUB	(bank adj note\$1) j1 (document\$1 pap ame (IC chip circu r semiconducting)) (bank adj note\$1) j1 (document\$1 pap cuit semiconductor ng)) and @pd>20030	ω	BRS	187
	· · · · · · · · · · · · · · · · · · ·	2004/02/24	USPAT; US-PGPUB	(bank adj note\$1) pj1 (document\$1 papecuit semiconductorng) and @pd>2003072	38	BRS	186
		2004/02/24 10:47	USPAT; US-PGPUB	(security near2 (strip thread)) same (size thickness width thick) and @pd>20030727	22	BRS	185
		_	B	polyimide adj10 polyaniline and @pd>20030727	6	BRS	184
		2004/02/24 10:43	USPAT; US-PGPUB	it semi yimide 727	Н	BRS	183
***************************************		2004/02/24 10:42	USPAT; US-PGPUB	(organic near2 polymer) same polyimide same polyaniline and @pd>20030727	Ъ	BRS	182
		2004/02/24 10:27	USPAT; US-PGPUB	it semiconductive se /imide same polyanili)727	9	BRS	181
		2004/02/24 10:21	USPAT; US-PGPUB	((paper cardboard currency passport) near5 (ic chip semiconduct\$3)) same (noncontact (non adj contact) contactlessly inductive capacitive) and @pd>20030727	4	180 BRS	180
Definition	Error De	Time Stamp e	DBs	Search Text	Hits	Туре	

0		2004/02/24 11:53	USPAT; US-PGPUB	tag near5 paper near5 (ic chip semiconductor) near5 (antenna coil) and @pd>20030727	<u> </u>	BRS	197
0		2004/02/24 11:48	EPO; JPO; DERWENT; IBM_TDB	exible flexibility ben tegrated adj circuit\$1 r5 paper and @pd>20030	0	BRS	196
0		2004/02/24 11:48	EPO; JPO; DERWENT; IBM_TDB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) semiconductor semiconductive) near5 organic and @pd>20030727	N	BRS	195
0		2004/02/24 11:45	USPAT; US-PGPUB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) semiconductor semiconductive) near5 organic and @pd>20030727	Φ	BRS	194
0		2004/02/24 11:45	USPAT; US-PGPUB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) semiconductor) near5 paper and @pd>20030727	ω	BRS	193
0		2004/02/24 11:44	EPO; JPO; DERWENT; IBM_TDB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) chip semiconductor) near5 (organic carbon polymer) and @pd>20030727	ω .	BRS	192
0		2004/02/24 11:43	EPO; JPO; DERWENT; IBM_TDB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) chip semiconductor) near5 (organic carbon) near5 polymer\$2 and @pd>20030727	0	BRS	191
0		2004/02/24	USPAT; US-PGPUB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) chip semiconductor) near5 (organic carbon) near5 polymer\$2 and @pd>20030727	0	BRS	190
0		2004/02/24	USPAT; US-PGPUB	(flexible flexibility bend\$4) near5 (ic (integrated adj circuit\$1) chip semiconductor) near5 (organic carbon polymer) and @pd>20030727	15	BRS	189
инонны	Error Definition	Time Stamp e	DBs	Search Text	Hits	Туре	

Type Hits 198 BRS 4	Search Text paper near5 (ic chip semicon (antenna coil) and @pd>20030 tag near5 (ic chip semicondu (antenna coil) near5 print\$3 @pd>20030727	DBs USPAT; USPAT; USPAT; USPAT; USPAT;	Time Stamp e n t t 2004/02/24 11:54 5 2004/02/24 15:45
8 BRS	chip semiconductor) near and @pd>20030727	USPAT; US-PGPUB	2004/02/2 11:54
99 BRS	hip semiconductor) near5 print\$3 and	USPAT; US-PGPUB	2004/02/ 15:45
200 IS&R 3	(("5108819") or ("5347144") or ("5566441")).PN.	USPAT; US-PGPUB	2004/02/24 15:45
201 BRS 759	(340/572.8.ccls. 257/774.ccls. 257/40.ccls. 361/728.ccls. 340/572.1.ccls. 340/572.7.ccls. 162/163.ccls. 340/572.7.ccls. 283/70.ccls. 162/163.ccls. 283/86.ccls. 235/451.ccls. 235/441.ccls. 283/72.ccls. 283/98.ccls. 283/83.ccls. 283/72.ccls. 283/98.ccls. 2902/1.ccls. 902/25.ccls. 235/492.ccls. 902/1.ccls. 902/25.ccls. 902/26.ccls. 902/29.ccls.) and @pd>20030727	USPAT; US-PGPUB	2004/02/24 17:44